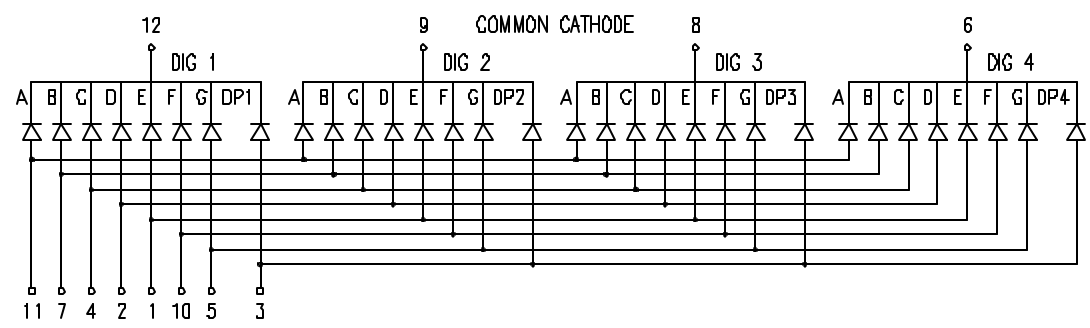
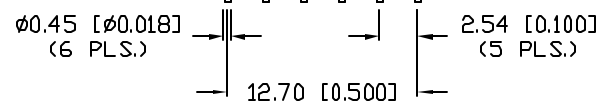
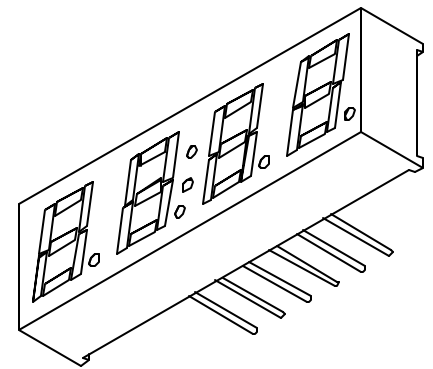
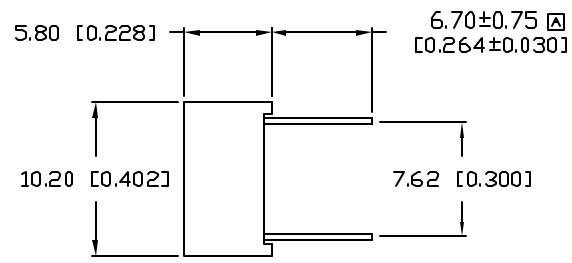
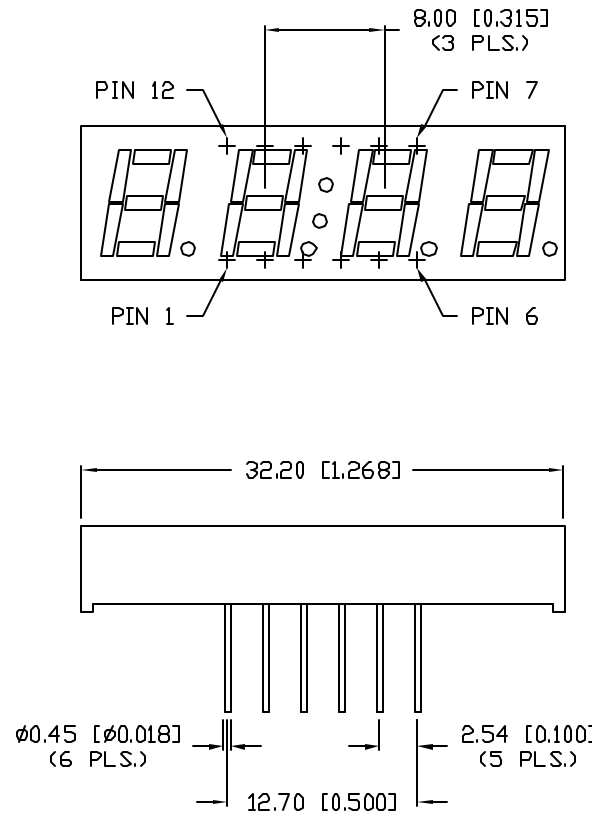


UNCONTROLLED DOCUMENT

| | | |
|-------------|-------------------------------------|---------|
| PART NUMBER | | REV. |
| LDQ-N284RI | | A |
| REV. | E.C.N. NUMBER AND REVISION COMMENTS | DATE |
| A | E.C.N. #10780. & REDRAWN. | 8.22.01 |



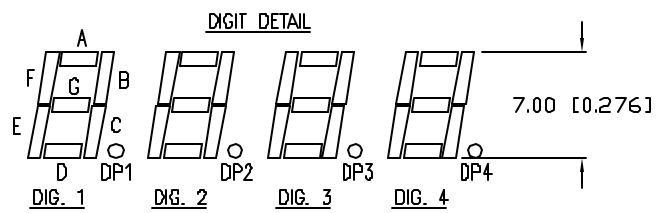
ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=10\text{mA}$

| PARAMETER | MIN | TYP | MAX | UNITS | TEST COND |
|-----------------|----------------------|------|-----|----------------|----------------------|
| PEAK WAVELENGTH | | 635 | | nm | |
| FORWARD VOLTAGE | | 2.0 | 2.5 | V_f | |
| REVERSE VOLTAGE | 5.0 | | | V_r | $I_f=100\mu\text{A}$ |
| AXIAL INTENSITY | | 5000 | | μcd | $I_f=10\text{mA}$ |
| EMITTED COLOR: | RED | | | | |
| FACE COLOR: | GRAY | | | | |
| SEGMENT COLOR: | MILKY WHITE DIFFUSED | | | | |

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

| PARAMETER | MAX | UNITS |
|--------------------------|------------|------------|
| PEAK FORWARD CURRENT* | 150 | mA |
| STEADY CURRENT | 30 | mA |
| POWER DISSIPATION | 105 | mW |
| DERATE FROM 25°C | -1.2 | mW/°C |
| OPERATING, STORAGE TEMP. | -30 TO +85 | °C |
| SOLDERING TEMP. | +260 | °C |
| 2.0mm FROM BODY | | 3 SEC. MAX |

* $t < 10\mu\text{S}$



UNCONTROLLED DOCUMENT

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=+DECIMAL PRECISION MAX.=+0.00 -0.00 -DECIMAL PRECISION

| | |
|---|-------------|
| REV. | PART NUMBER |
| A | LDQ-N284RI |
| 0.28" FOUR DIGIT SEVEN SEGMENT DISPLAY, RED, GRAY FACE WITH MILKY WHITE DIFFUSED SEGMENTS. | |

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RELIABILITY NOTE
 OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

| | | | |
|---|-------------|---|---------------|
|  | | 290 E. HELEN ROAD PALATINE, IL 60067-6976 PHONE: +1.847.359.2790 US WEB: www.lumex.com TW WEB: www.lumex.com.tw | |
| DRAWN BY: | CHECKED BY: | APPROVED BY: | DATE: 12.5.97 |
| gt | | | PAGE: 1 OF 1 |
| | | | SCALE: N/A |